



DMT8008LPS

PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	Rds(on)	I <sub>D</sub> Tc = +25°С
80V	7.8mΩ @ V <sub>GS</sub> = 10V	83A
00 V	$11m\Omega @ V_{GS} = 4.5V$	70A

### **Description and Applications**

This new generation MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in power management and load switches.

- **DC-DC converters**
- Load switches

Site 1:

#### **Features**

100% Unclamped Inductive Switching (UIS) Test in Production -• Ensures More Reliable and Robust End Application

80V N-CHANNEL ENHANCEMENT MODE MOSFET

- **High-Conversion Efficiency** •
- Low RDS(ON) Minimizes On-State Losses •
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2) •
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

### Mechanical Data

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)

PowerDI5060-8 D s [ D Pin 1 ΠD s[ ] D sГ G ] D G S Top View **Top View Bottom View** Internal Schematic Pin Configuration Site 2: D PowerDI5060-8/SWP (Type UX) sĽ ΠD s ΠD Pin 1 G s[ ΠD ΠD GГ S Top View Internal Schematic **Top View Bottom View** Pin Configuration 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

Notes:

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



### Ordering Information (Note 4)

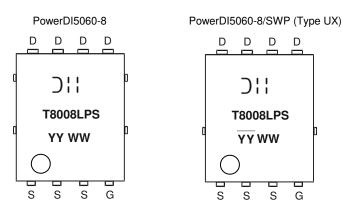
Part Number	Backaga	Packing		
Fart Nulliber	Package	Qty.	Carrier	
DMT8008LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DIVITOUU0LPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

D D

S G

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



⊃¦¦ = Manufacturer's Marking T8008LPS = Product Type Marking Code YYWW or  $\overline{YY}WW = Date Code Marking$ YY or  $\overline{YY}$  = Year (ex: 23 = 2023) WW = Week (01 to 53)

#### Maximum Ratings (@Tc = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	80	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)	ID	83 66	A		
Maximum Continuous Body Diode Forward Current (Note 5)			ls	69	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	330	A
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	330	А
Avalanche Current, L = 0.1mH (Note 6)			las	23	Α
Avalanche Energy, L = 0.1mH (Note 6)			Eas	26.5	mJ

# Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$	PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Reja	99	°C/W
Total Power Dissipation (Note 8)	TA = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	R <sub>0JA</sub>	45	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	83	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes: 5. Thermal resistance from junction to soldering point (on the exposed drain pad).

6. I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

7. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

8. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1 inch square copper plate.



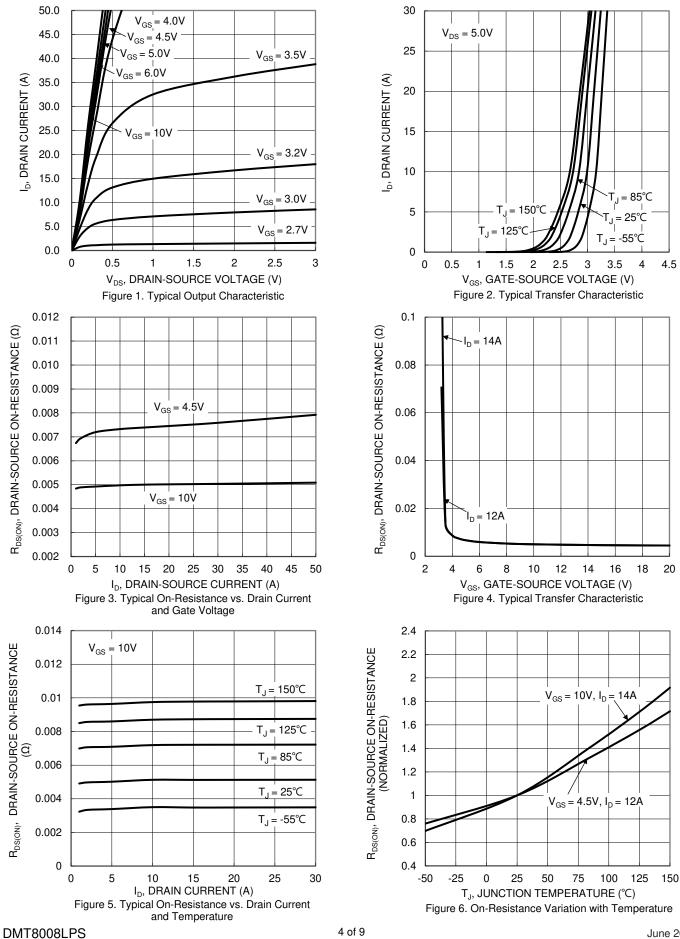
# Electrical Characteristics (@T<sub>C</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)						•	
Drain-Source Breakdown Voltage	BVDSS	80	—	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	$V_{DS} = 64V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	VGS(TH)	1.3	_	2.8	V	$V_{DS} = V_{GS}, I_D = 1mA$	
Static Drain-Source On-Resistance	Proven	_	5	7.8	mΩ	$V_{GS}=10V,\ I_D=14A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		8	11	11122	$V_{GS}=4.5V,I_D=12A$	
Diode Forward Voltage	V <sub>SD</sub>		0.8	1.2	V	$V_{GS} = 0V$ , $I_S = 14A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	2345	—	pF	$V_{DS} = 40V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss		842	—			
Reverse Transfer Capacitance	Crss		51.9	—			
Gate Resistance	Rg	_	1.7	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg		21.7	—			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg		41.2	—	nC	$V_{DD} = 40V, I_D = 2A$	
Gate-Source Charge	Qgs		5.0	—	no		
Gate-Drain Charge	Q <sub>gd</sub>		10.6	—			
Turn-On Delay Time	td(ON)	_	5.8	—			
Turn-On Rise Time	tR	_	5.4	_	ns	$\label{eq:VDD} \begin{split} V_{DD} &= 40V, \ V_{GS} = 10V \\ I_D &= 2A, \ R_g = 1.6\Omega \end{split}$	
Turn-Off Delay Time	tD(OFF)	_	24.5	_			
Turn-Off Fall Time	tF		43.2				
Body Diode Reverse Recovery Time	trr		61	—	ns		
Body Diode Reverse Recovery Charge	Qrr		181		nC	IF = 2A, dl/dt = 100A/µs	

Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



### DMT8008LPS

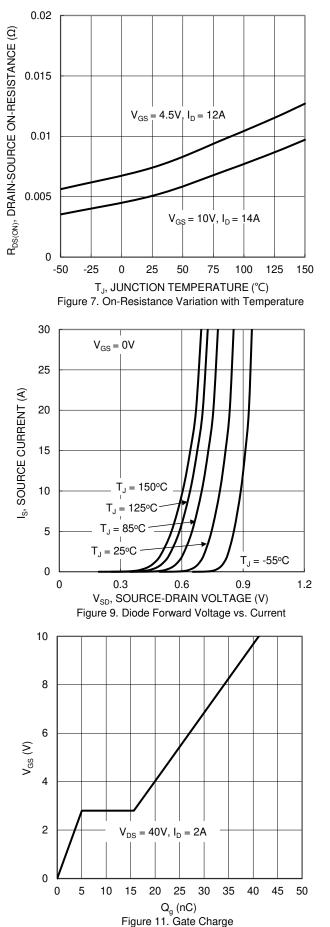


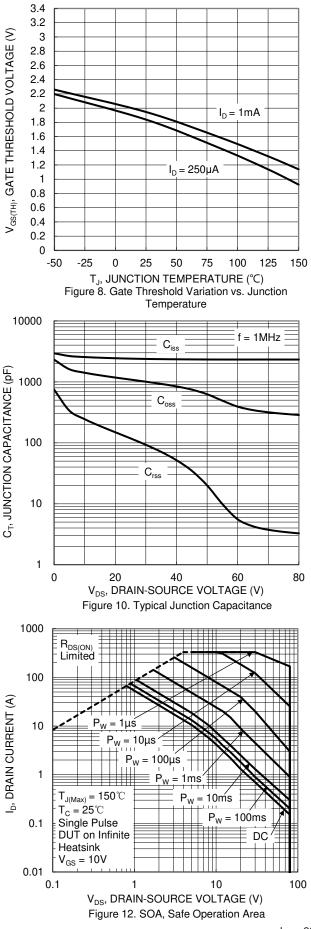
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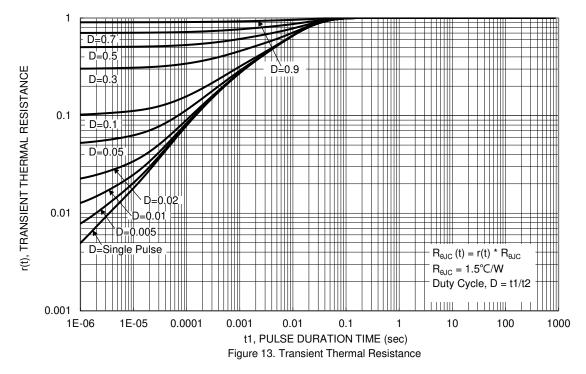






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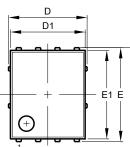


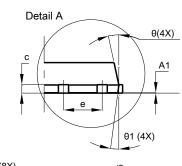
# **Package Outline Dimensions**

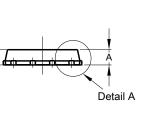
Please see http://www.diodes.com/package-outlines.html for the latest version.

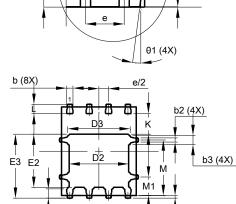
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Site 1:







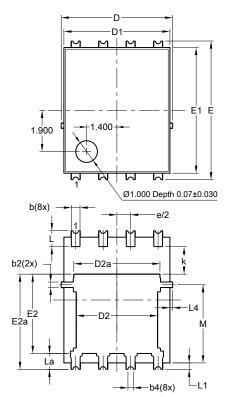


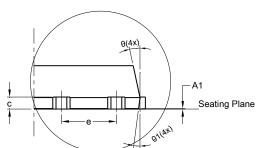
	PowerDI5060-8				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E		6.15 BSC			
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
К	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
01	6°	8°	7°		
Al	Dimens	ions in m	nm		

Site 2:

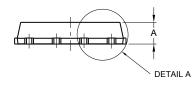
### PowerDI5060-8/SWP (Type UX)

PowerDI5060-8





DETAIL A



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	(	).25REF		
С	0.230		0.277	
D		.15 BS0		
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	6.40 BSC		
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC	)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a		.050RE		
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All	All Dimensions in mm			

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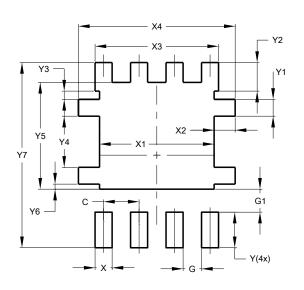


# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

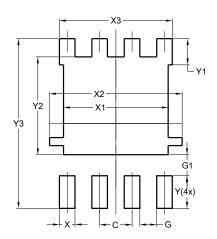
#### PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
¥7	6.610

Site 2:

#### PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
X3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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